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DM74ALS174, DM74ALS175
Hex/Quad D-Type Flip-Flops with Clear

Features

- Advanced oxide-isolated ion-implanted Schottky TTL process
- Pin and functional compatible with LS family counterpart
- Typical clock frequency maximum is 80MHz
- Switching performance guaranteed over full temperature and V_{CC} supply range

General Description

These positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic. Both have an asynchronous clear input, and the quad (DM74ALS175) version features complementary outputs from each flip-flop.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the HIGH or LOW level, the D input signal has no effect at the output.

Ordering Information

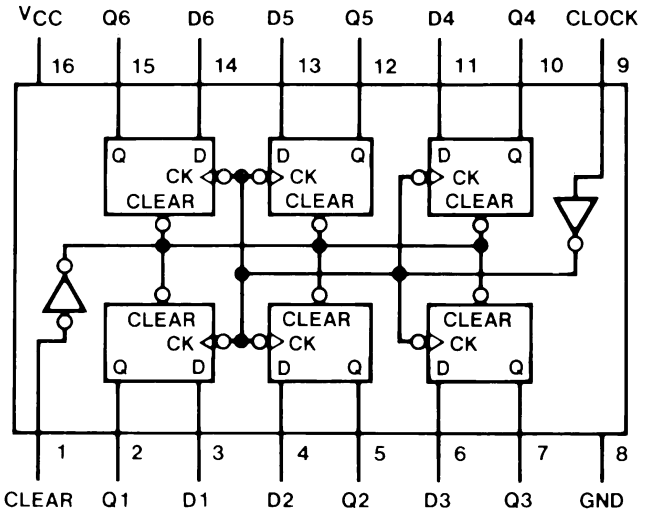
Ordering Code	Package Number	Package Description
DM74ALS174M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS174SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS175M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
DM74ALS175SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS175N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter “X” to the ordering number.

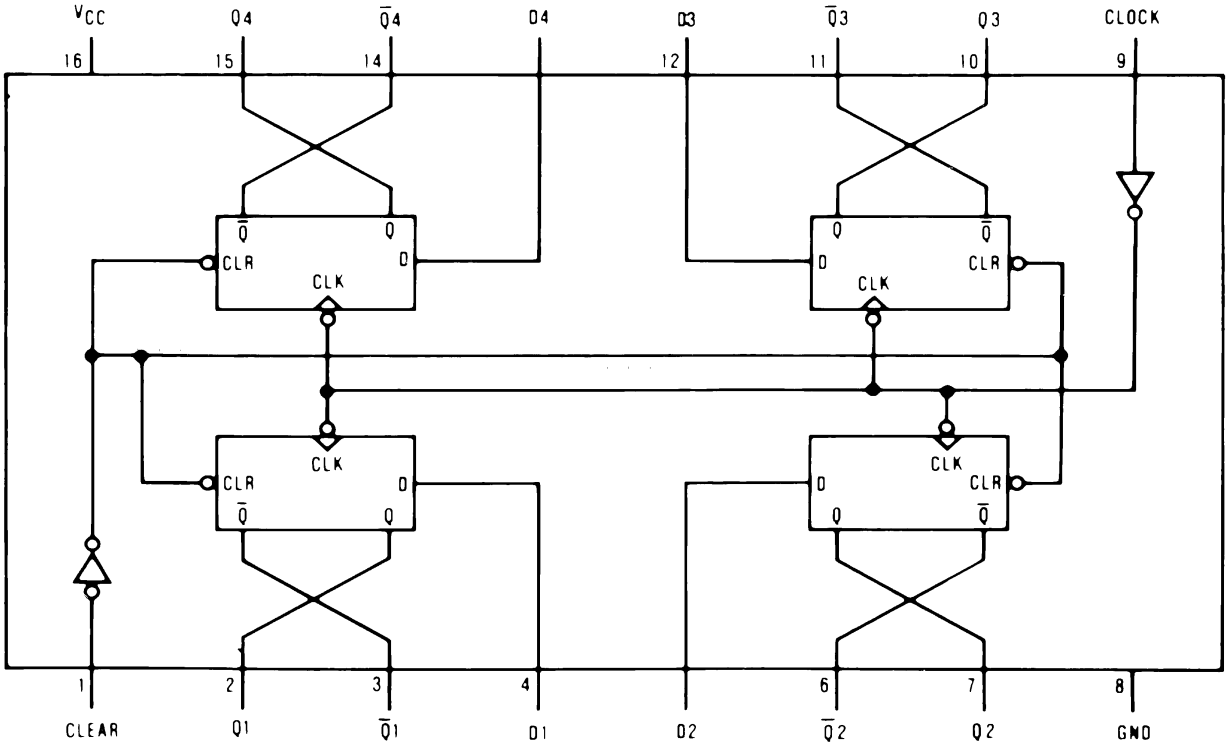
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Connection Diagrams

DM74ALS174



DM74ALS175



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Function Table

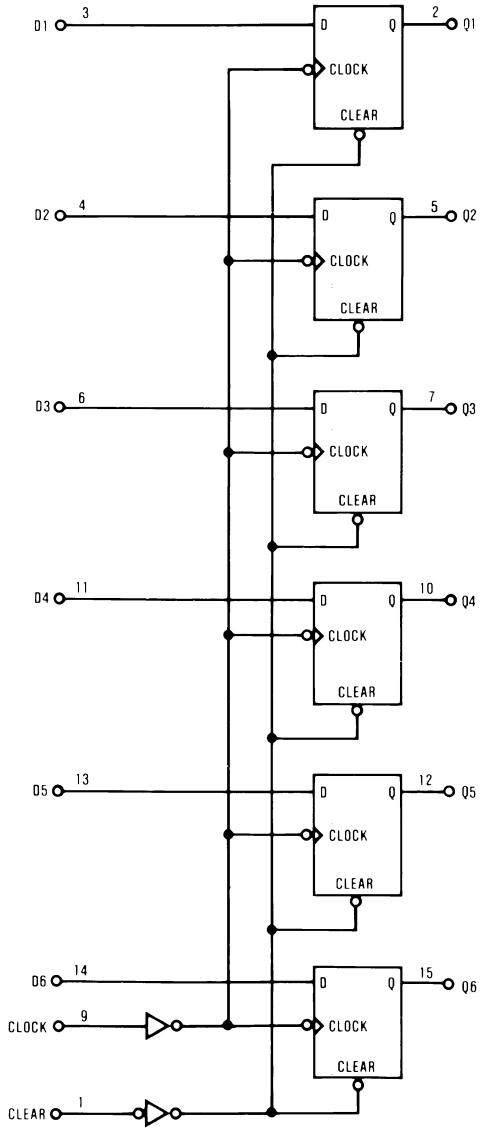
Inputs			Outputs	
Clear	**Clock**	**D**	**Q**	$\overline{Q}^{(1)}$
L	X	X	L	H
H	↑	H	H	L
H	↑	L	L	H
H	L	X	Q_0	$\overline{Q}_0$

H = HIGH Level (steady state) L = LOW Level (steady state)
X = Don't Care ↑ = Transition from LOW-to-HIGH Level
Q_0 = the level of Q before the indicated steady-state input conditions were established.

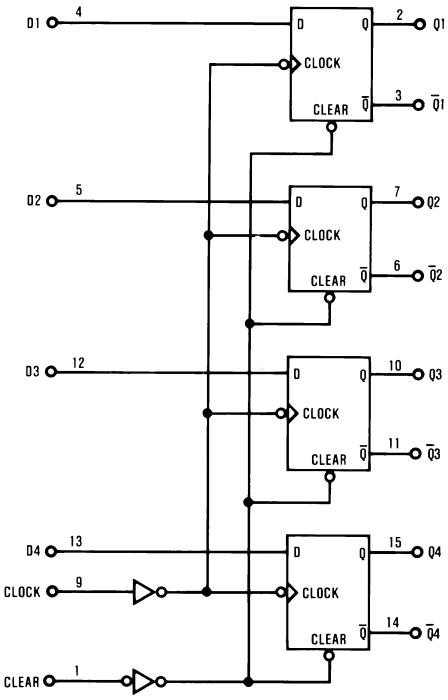
Note:
1. Applies to DM74ALS175 only.

Logic Diagrams

DM74ALS174



DM74ALS175



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	7V
V_I	Input Voltage	7V
T_A	Operating Free Air Temperature Range	0°C to +70°C
T_{STG}	Storage Temperature Range	–65°C to +150°C
θ_{JA}	Typical Thermal Resistance	
	N Package	77.9°C/W
	M Package	107.3°C/W

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter		Min.	Nom.	Max.	Units
V_{CC}	Supply Voltage		4.5	5	5.5	V
V_{IH}	HIGH Level Input Voltage		2			V
V_{IL}	LOW Level Input Voltage				0.8	V
I_{OH}	HIGH Level Output Current				–0.4	mA
I_{OL}	LOW Level Output Current				8	mA
t_W	Pulse Width	Clock HIGH or LOW	10			ns
		$\overline{\text{Clear}}$ LOW	10			
t_{SETUP}	Setup Time(2)	Data Input	10↑			ns
		$\overline{\text{Clear}}$, Inactive State	6↑			
t_{HOLD}	Data Hold Time(2)		0↑			ns
f_{CLOCK}	Clock Frequency		0		50	MHz
T_A	Free Air Operating Temperature		0		70	°C

Note:

2. The symbol ↑ indicates that the rising edge of the clock is used as reference.

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Electrical Characteristics

Over recommended operating free air temperature range. All typical values are measured at V_{CC} = 5V, T_A = 25°C.

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Units
V_{IK}	Input Clamp Voltage	V_{CC} = 4.5V, I_{IN} = –18 mA				–1.5	V
V_{OH}	HIGH Level Output Voltage	I_{OH} = –400µA, V_{CC} = 4.5V to 5.5V		V_{CC} – 2	V_{CC} – 1.6		V
V_{OL}	LOW Level Output Voltage	V_{CC} = 4.5V, I_{OL} = 8mA			0.35	0.5	V
I_I	Input Current at Max. Input Voltage	V_{CC} = 5.5V, V_{IN} = 7V				0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = 5.5V, V_{IH} = 2.7V				20	µA
I_{IL}	LOW Level Input Current	V_{CC} = 5.5V, V_{IN} = 0.4V				–0.1	mA
I_O	Output Drive Current	V_{CC} = 5.5V, V_O = 2.25V		–30		–112	mA
I_{CC}	Supply Current	V_{CC} = 5.5V, Clock = 4.5V, Clear = GND, D Input = GND	DM74ALS174		11	19	mA
			DM74ALS175		8	14	

Switching Characteristics

Over recommended operating free air temperature range.

Symbol	Parameter	Conditions	Min.	Max.	Units
f_{MAX}	Maximum Clock Frequency	R_L = 500Ω, C_L = 50pF, V_{CC} = 4.5V to 5.5V	50		MHz
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output From Clear (175 Only)		5	18	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output From Clear		8	23	ns
t_{PLH}	Propagation Delay Time, LOW-to-HIGH Level Output From Clock		3	15	ns
t_{PHL}	Propagation Delay Time, HIGH-to-LOW Level Output From Clock		5	17	ns

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Physical Dimensions

Dimensions are in millimeters unless otherwise noted.

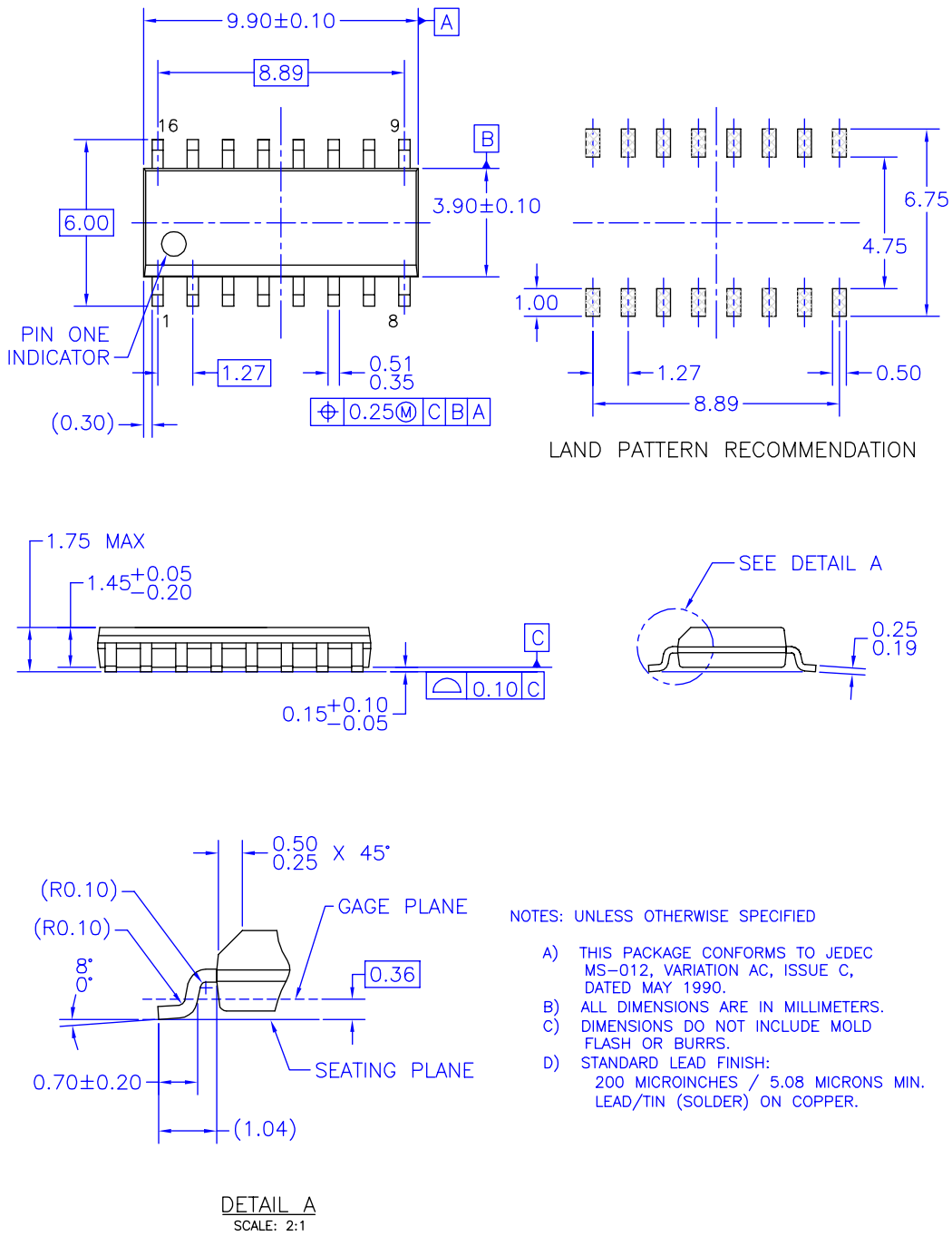
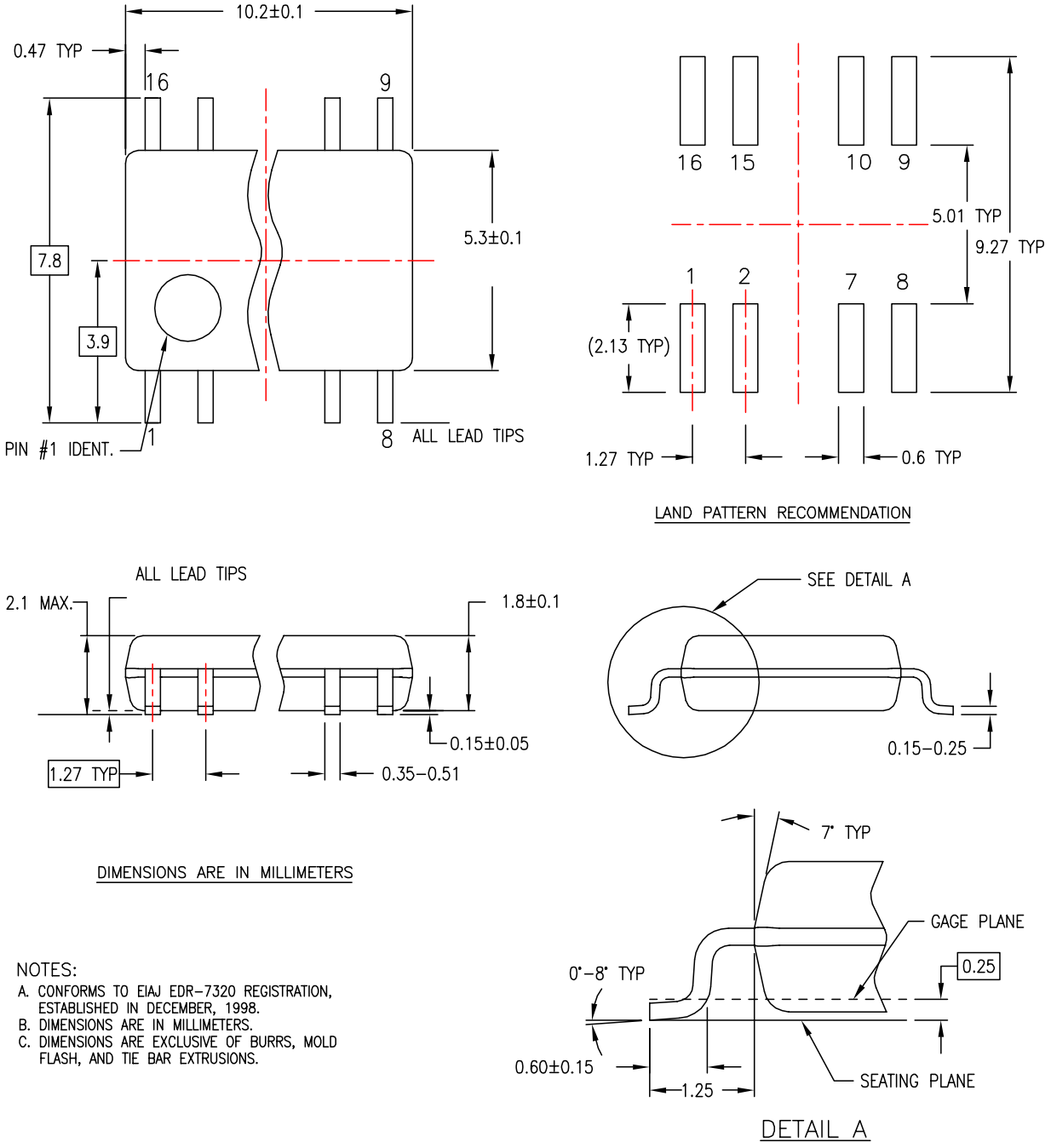


Figure 1. 16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M16A

Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.



NOTES:

A. CONFORMS TO EIAJ EDR–7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DREVC

Figure 2. 16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M16D

Physical Dimensions (Continued)

Dimensions are in inches (millimeters) unless otherwise noted.

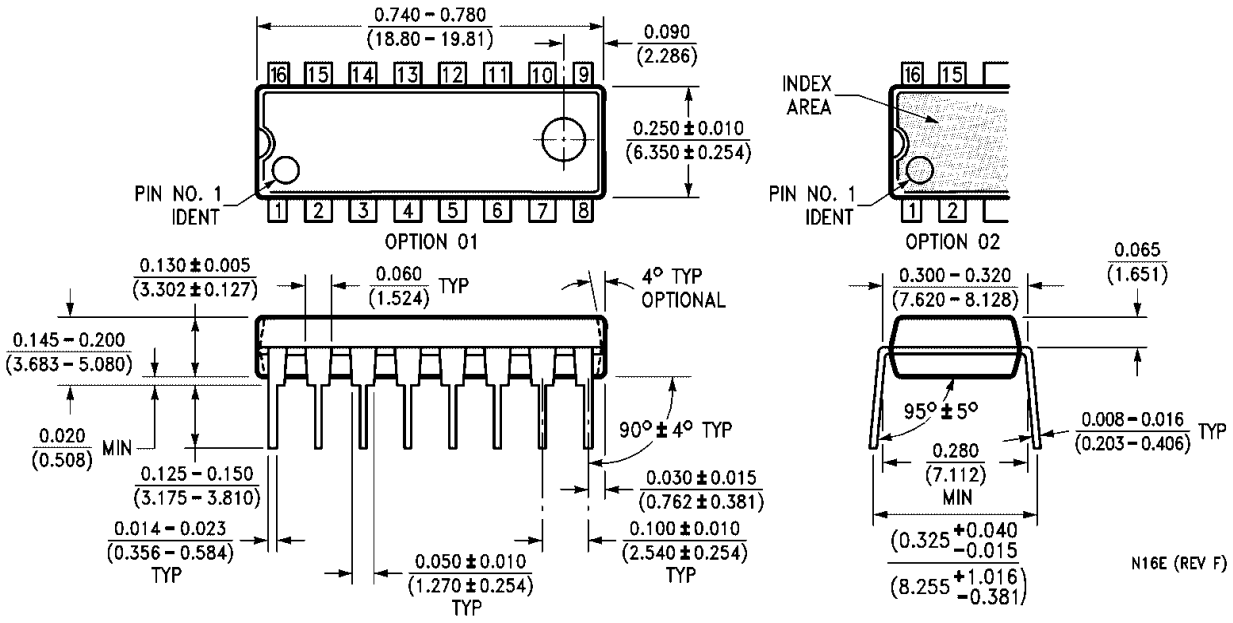


Figure 3. 16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N16E

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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